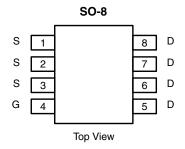




Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}$ (Ω) Max.	I _D (A) ^a	Q _g (Typ.)			
	0.023 at V _{GS} = 10 V	11.1				
100	0.024 at $V_{GS} = 7.5 \text{ V}$	10.8	9.7 nC			
	0.031 at V _{GS} = 4.5 V	9.5				



Ordering Information:

Si4056DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

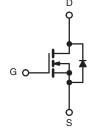
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912



HALOGEN FREE

APPLICATIONS

- DC/DC Primary Side Switch
- Telecom/Server
- Industrial
- Synchronous Rectification



N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		11.1	
Continuous Brain Correct /T 450 °C)	T _C = 70 °C		8.8	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	· I _D	7.3 ^{b, c}	
	T _A = 70 °C		5.8 ^{b, c}	Α .
Pulsed Drain Current (t = 300 μs)		I _{DM}	70	A
	T _C = 25 °C		5.1	
Continuous Source-Drain Diode Current	T _A = 25 °C	- I _S	2.2 ^{b, c}	
Single Pulse Avalanche Current	1 01 mll	I _{AS}	15	
Avalanche Energy L = 0.1 mH		E _{AS}	11.2	mJ
	T _C = 25 °C		5.7	
Mayimum Dayyar Dissination	T _C = 70 °C		3.6	w
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	VV
	T _A = 70 °C		1.6 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	35	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	18	22	- C/VV		

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- d. Maximum under steady state conditions is 85 °C/W.

Document Number: 62662 S12-1136-Rev. A, 21-May-12 For technical questions, contact: pmostechsupport@vishav.com

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•	•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		67		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.5		2.8	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zawa Cata Waltana Dunin Cumunt		V _{DS} = 100 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 15 A		0.017	0.023		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, I_D = 12 \text{ A}$		0.018	0.024		
		V _{GS} = 4.5 V, I _D = 10 A		0.022	0.031		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		26		S	
Dynamic ^b						l	
Input Capacitance	C _{iss}			900			
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		340		pF	
Reverse Transfer Capacitance	C _{rss}			31			
Total Gate Charge	Q_g $V_{DS} = 50 \text{ V, } V_{GS} = 10 \text{ V, } I_D = 10 \text{ A}$	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		19.6	29.5		
			9.7	15	†		
Gate-Source Charge	Q_{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		2.8		nC	
Gate-Drain Charge	Q _{gd}			4.3			
Output Charge	Q _{oss}	V _{DS} = 50 V, V _{GS} = 0 V		26.2	40		
Gate Resistance	R_g	f = 1 MHz	0.2	0.85	1.7	Ω	
Turn-On Delay Time	t _{d(on)}			13	26		
Rise Time	t _r	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega$		14	28		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$		19	38		
Fall Time	t _f			10	20	no	
Turn-On Delay Time	t _{d(on)}			11	22	ns	
Rise Time	t _r	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega$		10	20	- -	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		20	40		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			5.1		
Pulse Diode Forward Current ^a	I _{SM}				70	A	
Body Diode Voltage	V _{SD}	I _S = 4 A		0.77	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			34	65	ns	
Body Diode Reverse Recovery Charge				34	65	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		20			
Reverse Recovery Rise Time	t _b			14		ns	

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

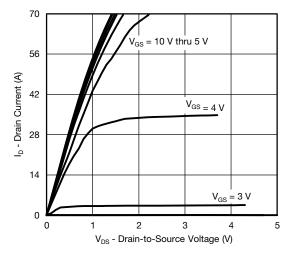
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

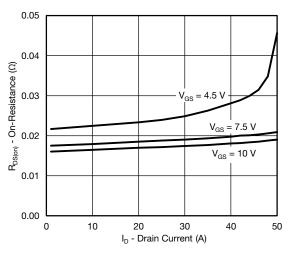


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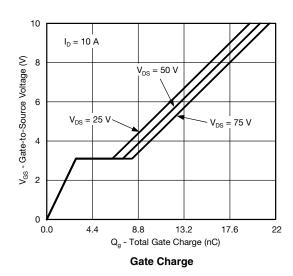
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

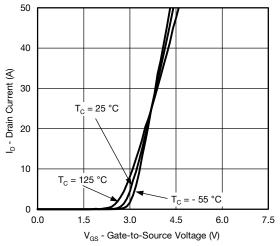


Output Characteristics

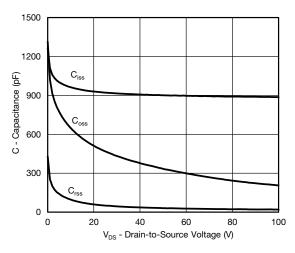


On-Resistance vs. Drain Current

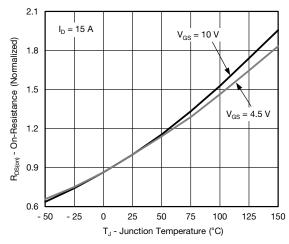




Transfer Characteristics



Capacitance

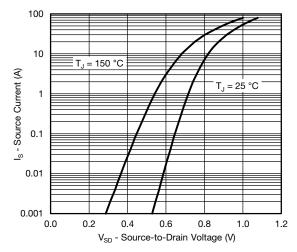


On-Resistance vs. Junction Temperature

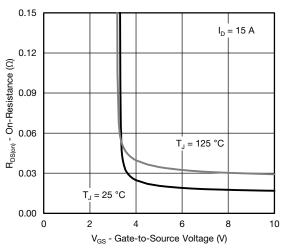
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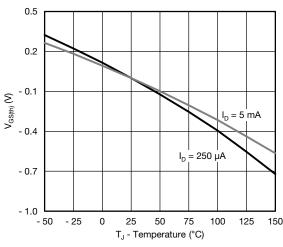
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



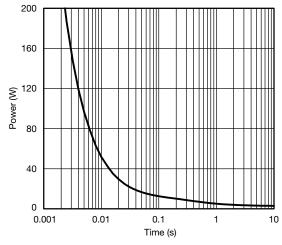
Source-Drain Diode Forward Voltage



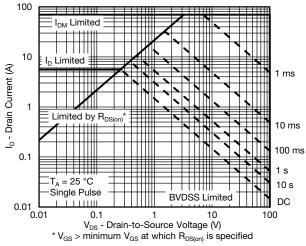
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



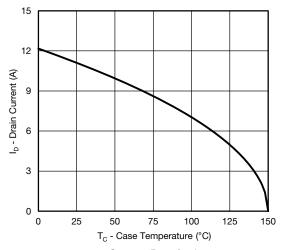
Single Pulse Power, Junction-to-Ambient



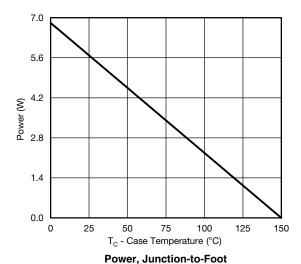


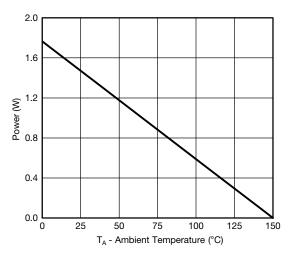
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*





Power, Junction-to-Ambient

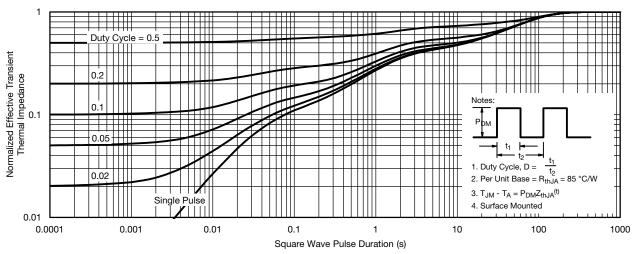
^{*} The power dissipation PD is based on TJ(max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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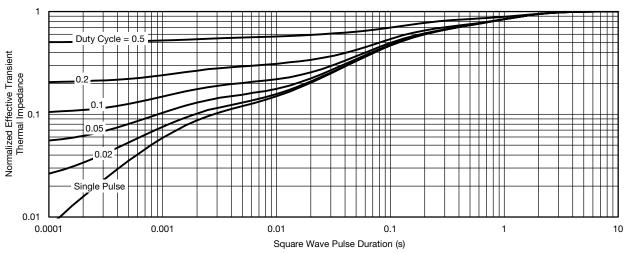
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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